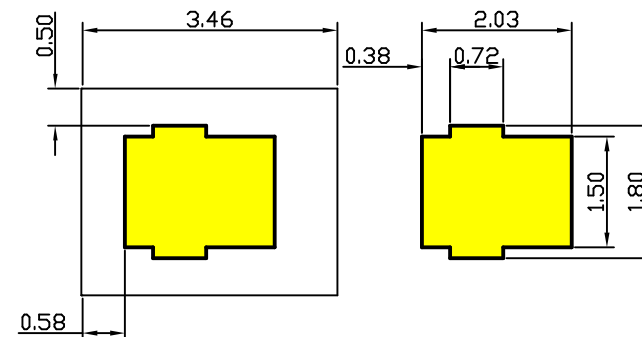
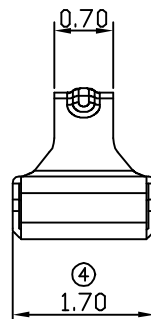
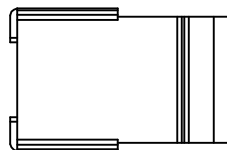
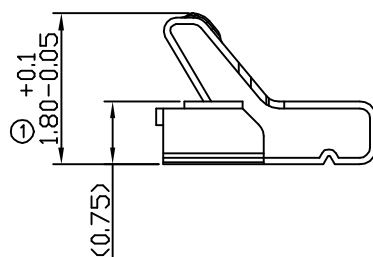
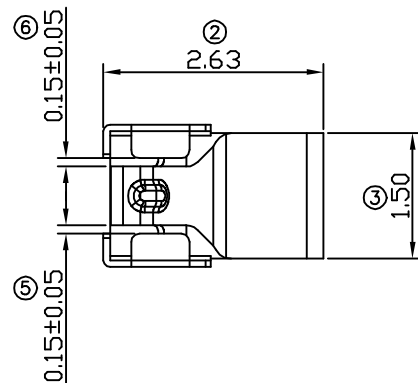
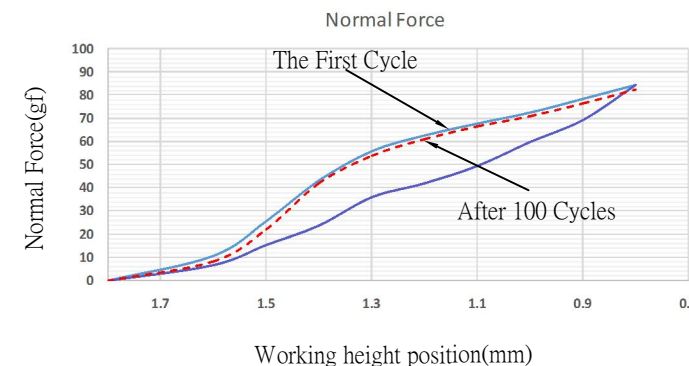


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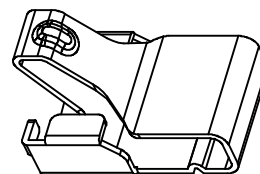
RECOMMENDED SOLDERING PCB LAYOUT

TOLERANCE(.XX±0.05)



Note:

1. Material: Copper Alloy Thickness 0.08mm
2. Electroplate:
 - Gold Flash on contact area
 - Gold Flash on solder area
 - Nickel underplating over all
3. Electrical Characteristics:
 - 3-1 Current Voltage: 12V
 - 3-2 Current Rate: 3A
 - 3-3 Contact Resistance: Normal Compression<30mΩ
4. Working Height of Application: 0.80 ~ 1.40mm
5. Spring Force Tolerance is ±20gf
6. Operating Temperature: -20℃~+85℃



00	07/01-'15	Design creation			
REV	Date	Description			
DRAFT	Hardy Hsieh	DATE	07/01-'15	RoHS Compatible	
CHECKER	Justin Wu	DATE	07/01-'15		
APPROVAL	Jacky Lin	DATE	07/01-'15	SHEET	1-2
				SCALE	Not to scale
				UNIT	mm
					⌀

TOLERANCE/CLASS			
RANGE(mm)	1	2	3
≤30	±0.10	0.15	0.20
30<~120	±0.15	0.20	0.30
120<~300	±0.20	0.30	0.50
300<	±0.30	0.50	0.80
ANGLES	±2.5°		



EMI STOP CORP.

EMISTOP
QM-18A6Q2G

CUS P/N